TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of			
Invention			

Integrated Circuit Chip Having A Ringed Wiring Layer Interposed Between A Contact Layer And A Wiring Grid

Application Number :

Date

First Named Applicant: Thomas R. Bednar

Confirmation Number:

Attorney Docket Number: BUR920020107US1

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Submitted By:	Elec. Sign.	Sign. Capacity
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Registered Number: 39,220	s /	-

Documents being submitted:	Files	
us-ids	BUR920020107US1-usidst.xml	
	us-ids.dtd	
	us-ids.xsl	
us-assignment	BUR920020107US1-usassn.xml	
	us-assignment.xsl	
	us-assignment.dtd	
	BUR920020107US1assign1.tif	
	BUR920020107US1assign2.tif	
	BUR920020107US1assign3.tif	
us-request	BUR920020107US1-usrequ.xml	
	us-request.dtd	
	us-request.xsl	
us-fee-sheet	BUR920020107US1-usfees.xml	
	us-fee-sheet.xsl	
	us-fee-sheet.dtd	
us-declaration	BUR920020107US1dec1.tif	
us-declaration	BUR920020107US1dec2.tif	
us-declaration	BUR920020107US1dec3.tif	
us-declaration	BUR920020107US1dec4.tif	
us-declaration	BUR920020107US1dec5.tif	
application-body	BUR920020107spec-trans.xml	
	us-application-body.xsl	
	application-body.dtd	
	wipo.ent	
	mathml2.dtd	
	mathml2-qname-1.mod	
	isoamsa.ent	
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BUR920020107drw2.tif BUR920020107drw3.tif BUR920020107drw4.tif

Comments

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